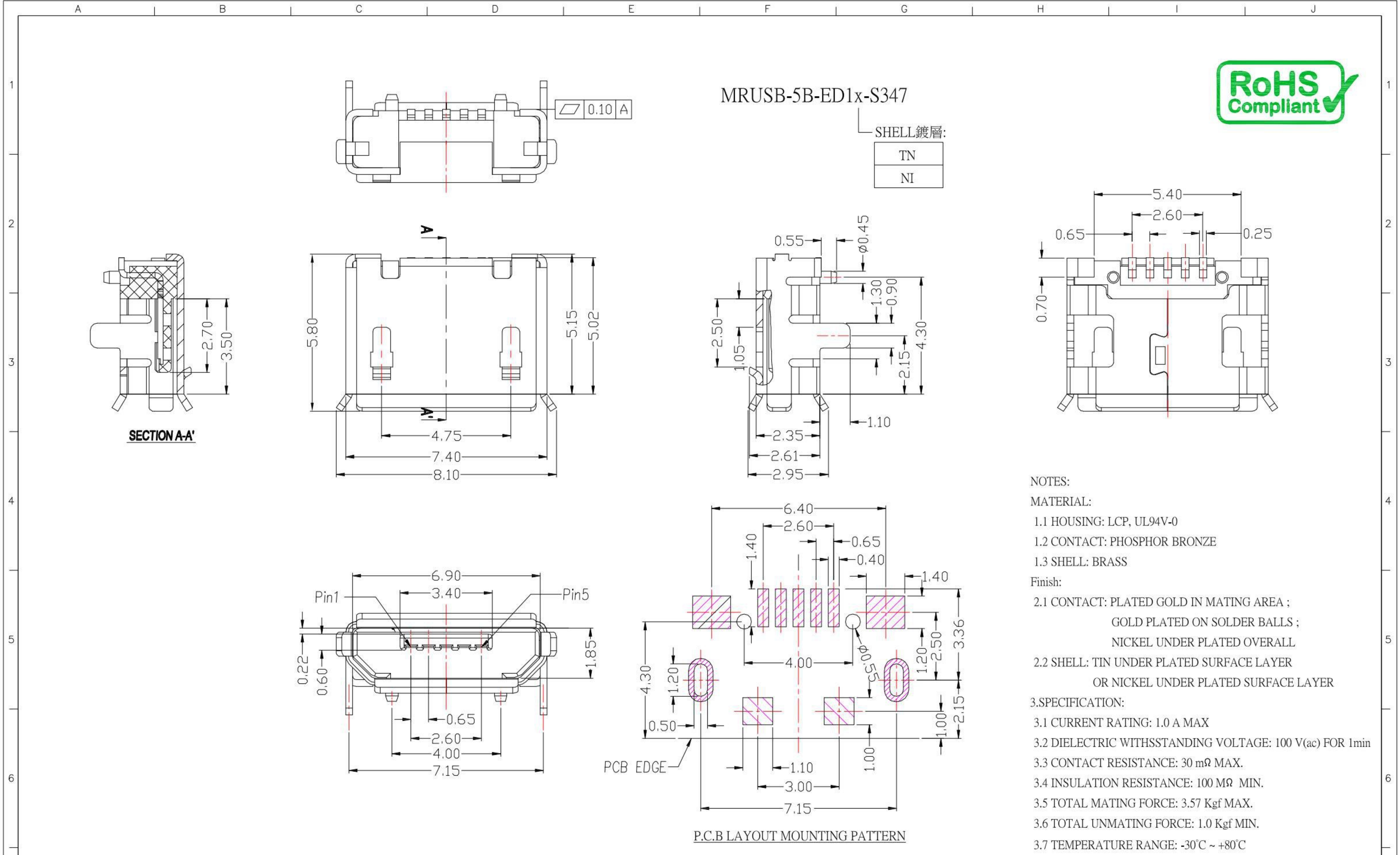




- NOTES:
- MATERIAL:
- 1.1 HOUSING: LCP, UL94V-0
 - 1.2 CONTACT: PHOSPHOR BRONZE
 - 1.3 SHELL: BRASS
- Finish:
- 2.1 CONTACT: PLATED GOLD IN MATING AREA ;
GOLD PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL
 - 2.2 SHELL: TIN UNDER PLATED SURFACE LAYER
OR NICKEL UNDER PLATED SURFACE LAYER
- 3.SPECIFICATION:
- 3.1 CURRENT RATING: 1.0 A MAX
 - 3.2 DIELECTRIC WITHSSTANDING VOLTAGE: 100 V(ac) FOR 1min
 - 3.3 CONTACT RESISTANCE: 30 mΩ MAX.
 - 3.4 INSULATION RESISTANCE: 100 MΩ MIN.
 - 3.5 TOTAL MATING FORCE: 3.57 Kgf MAX.
 - 3.6 TOTAL UNMATING FORCE: 1.0 Kgf MIN.
 - 3.7 TEMPERATURE RANGE: -30°C ~ +80°C

7					KSD 科斯达电子科技有限公司 SWITCH CONNECTOR 全球互联网组件制造企业 KSD ELECTRONIC TECHNOLOGY Co., LTD TOLERANCE UNLESS OTHERWISE STATED : Up to 5 Above 5 ~ 15 Above 15 ~ 30 Above 30 ~ 50 Angle ±0.2 ±0.3 ±0.4 ±0.5 ±0.3° 3RD. ANGEL'S  UNITS MM	DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR		7						
	3	更新樣式	Lan	041719		CHECKED BY:	DATE	FINISH		MODLE	MICRO USB 5B/F SMT 插板7.15 腳長 1.10 ,有柱 有捲邊								
	2	更新底部樣式	Jack	012119		Jacky Chen	04/17/19		SCALE	1 : 1	DWG NO.	MRUSB-5B-ED1x-S347		SIZE					
1	新增尺寸	Jack	031218	APPROVED BY:	DATE	SHEET NO.	1 of 1	PART NO.	MRUSB-5B-ED1x-S347	A4									
ITEM NO.	DESCRIPTION	DRAWN	DATE	Tony Kao	04/17/19					VER	R3								
A		B		C		D		E		F		G		H		I		J	